LINX® TECHNOLOGIES
WIRELESS MADE SIMPLE®

TXM-315-LC
TXM-418-LC
TXM-433-LC

LC SERIES TRANSMITTER MODULE DATA GUIDE

DESCRIPTION

The LC Series is ideally suited for volume use in OEM applications such as remote control, security, identification, and periodic data transfer. Housed in a compact surface-mount package, the LC Series transmitter utilizes a highly-optimized SAW architecture to achieve an unmatched blend of performance, size, efficiency, and cost. When paired with a matching LC Series or LR Series receiver, a highly reliable wireless link is formed, capable of transferring serial data at distances in excess of 300 feet (LC) or up to 3,000 feet (LR). No external RF components are required (except an antenna), making design and integration straightforward, even for engineers without previous RF experience.

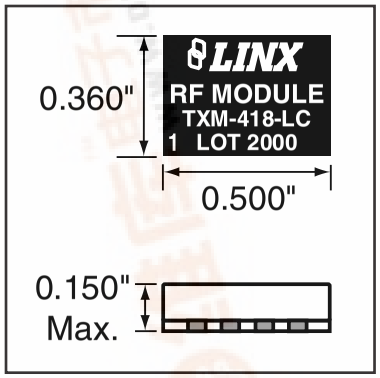


Figure 1: Package Dimensions

FEATURES

- Low cost
- No external RF components required
- Ultra-low power consumption
- Compact surface-mount package
- Stable SAW-based architecture
- Supports data rates to 5,000bps
- Wide supply range (2.7 to 5.2VDC)
- Direct serial interface
- Low harmonics
- No production tuning

APPLICATIONS INCLUDE

- Remote Control
- Keyless Entry
- Garage / Gate Openers
- Lighting Control
- Medical Monitoring / Call Systems
- Remote Industrial Monitoring
- Periodic Data Transfer
- Home / Industrial Automation
- Fire / Security Alarms
- Remote Status Sensing
- Long-Range RFID
- Wire Elimination

ORDERING INFORMATION

PART #	DESCRIPTION
TXM-315-LC	Transmitter 315MHz
TXM-418-LC	Transmitter 418MHz
TXM-433-LC	Transmitter 433MHz
RXM-315-LC	Receiver 315MHz
RXM-418-LC	Receiver 418MHz
RXM-433-LC	Receiver 433MHz
EVAL-***-LC	Basic Evaluation Kit
*** = Frequency	
Transmitters are supplied in tubes of 50 pcs.	

Revised 1/28/08

ELECTRICAL SPECIFICATIONS

Parameter	Designation	Min.	Typical	Max.	Units	Notes
POWER SUPPLY						
Operating Voltage	V_{CC}	2.7	–	5.2	VDC	–
Supply Current	I_{CC}	–	3.0	6.0	mA	1,4
Power-down Current	I_{PDN}	–	–	1.5	µA	2
TRANSMITTER SECTION						
Transmit Frequency:	F_C					
TXM-315-LC		–	315	–	MHz	–
TXM-418-LC		–	418	–	MHz	–
TXM-433-LC		–	433.92	–	MHz	–
Center Frequency Accuracy	–	-50	–	+50	kHz	–
Output Power	P_o	-4	0	+4	dBm	3
Harmonic Emissions	P_H	–	–	-40	dBc	3
Data Rate	–	100	–	5,000	bps	–
Data Input:						
Logic Low	V_{IL}	0.0	–	0.4	VDC	–
Logic High	V_{IH}	2.5	–	Vcc	VDC	–
ANTENNA PORT						
RF Output Impedance	R_{OUT}	–	50	–	Ω	5
TIMING						
Transmitter Turn-On Time	–	–	30	80	µSec	5
Transmitter Turn-Off Time	–	–	–	100	nSec	5
ENVIRONMENTAL						
Operating Temperature Range	–	-30	–	+70	°C	5

Table 1: LC Series Transmitter Specifications

Notes

1. Current draw with DATA pin held continuously high.
2. Current draw with DATA pin low.
3. RF out connected to a 50Ω load.
4. LADJ through 430Ω resistor.
5. Characterized, but not tested.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage V_{CC}	-0.3	to	+6.0	VDC
Any Input or Output Pin	-0.3	to	V_{CC}	VDC
Operating Temperature	-30	to	+70	°C
Storage Temperature	-45	to	+85	°C
Soldering Temperature	+225°C for 10 seconds			

***NOTE* Exceeding any of the limits of this section may lead to permanent damage to the device. Furthermore, extended operation at these maximum ratings may reduce the life of this device.**

CAUTION

This product incorporates numerous static-sensitive components. Always wear an ESD wrist strap and observe proper ESD handling procedures when working with this device. Failure to observe this precaution may result in module damage or failure.

PERFORMANCE DATA

These performance parameters are based on module operation at 25°C from a 3.3VDC supply unless otherwise noted. Figure 2 illustrates the connections necessary for testing and operation. It is recommended all ground pins be connected to the ground plane.

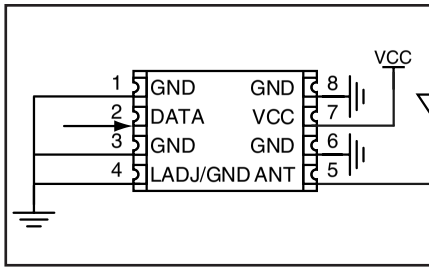


Figure 2: Test / Basic Application Circuit

TYPICAL PERFORMANCE GRAPHS

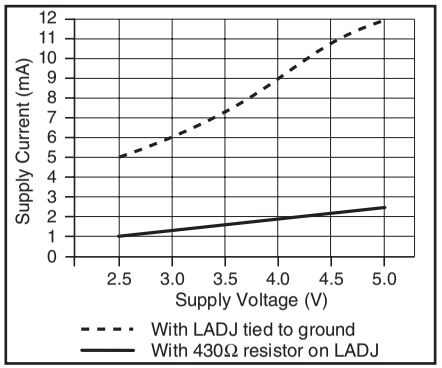


Figure 3: Current vs. Supply Voltage

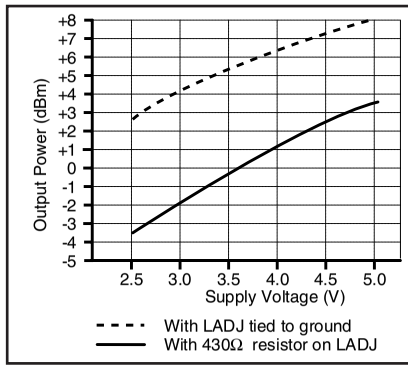


Figure 4: Output Power vs. Supply Voltage

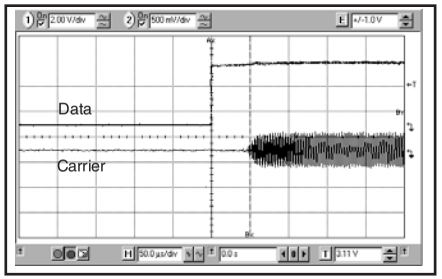


Figure 5: Typical Oscillator Turn-On Time

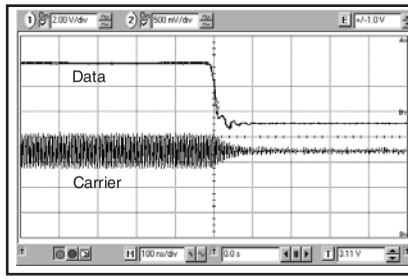


Figure 6: Typical Oscillator Turn-Off Time

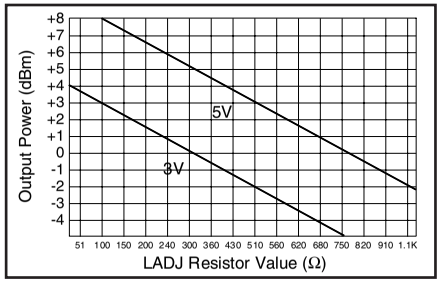


Figure 7: Output Power vs. LADJ Resistor

PIN ASSIGNMENTS

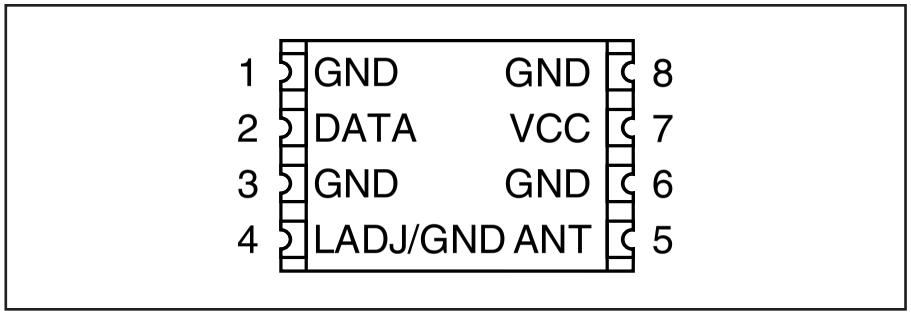


Figure 8: LC Series Transmitter Pinout (Top View)

PIN DESCRIPTIONS

Pin #	Name	Description
1	GND	Analog Ground
2	DATA	Digital Data Input
3	GND	Analog Ground
4	LADJ/GND	Level Adjust. This line can be used to adjust the output power level of the transmitter. Connecting to ground will give the highest output, while placing a resistor to ground will lower the output level (see Figure 7 on Page 3).
5	ANT	50-ohm RF Output
6	GND	Analog Ground
7	V_{CC}	Supply Voltage
6	GND	Analog Ground

MODULE DESCRIPTION

The LC Series transmitter is a low-cost, high-performance Surface Acous
Wave (SAW) based Carrier-Present Carrier-Absent (CPCA) transmitter capab
of sending serial data at up to 5,000bps. The LC's compact surface-mou
package integrates easily into existing designs and is equally friendly
prototype and volume production. The LC's ultra-low power consumption mak
it ideally suited for battery-powered products. When combined with a Linx LC
LR Series receiver, a reliable RF link is formed, capable of transferring data ov
line-of-sight distances in excess of 300 feet (with the LC Series receiver) or
to 3,000 feet (with the LR Series receiver).

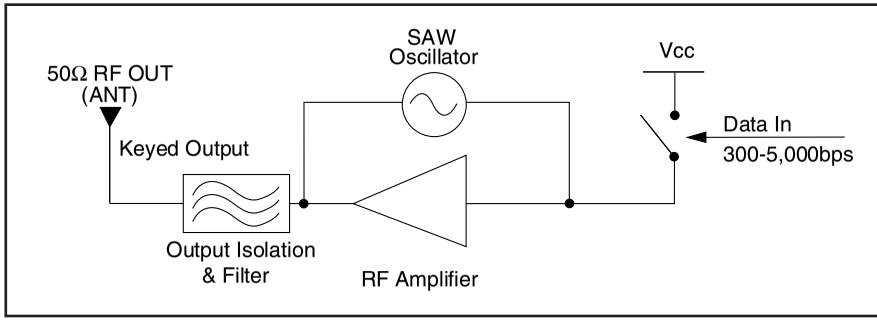


Figure 9: LC Series Transmitter Block Diagram

THEORY OF OPERATION

The LC Series transmitter transmits data using Carrier-Present Carrier-Abse
(CPCA) modulation. This type of AM modulation is often referred to by oth
designations, including Continuous Wave (CW) and On-Off Key (OOK). Th
type of modulation represents a logic low '0' by the absence of a carrier and
logic high '1' by the presence of a carrier. This method affords numero
benefits. Three of the most important are:

1) Cost-effectiveness due to design simplicity.

2) No minimum data rate or mark / space ratio requirement.

3) Higher output power and thus greater range in countries (such as the U.S
where output power measurements are averaged over time. (Please refer to Li
Application Note AN-00130).

The LC Series transmitter is based on a simple but highly optimized architectu
that achieves a high fundamental output power with low harmonic content. Th
ensures that approval requirements can be met without external filt
components. The LC Series transmitter is exceptionally stable over tim
temperature, and physical shock as a result of the precision Surface Acous
Wave (SAW) frequency reference. Due to the accuracy of the SAW device, mo
of the output power is concentrated in a narrow bandwidth. This allows t
receiver's bandwidth to be quite narrow, thus increasing sensitivity and reduci
susceptibility to near-band interference. The quality of components and over
architecture utilized in the LC Series is extraordinary in a low-cost RF device a
is one reason the LC transmitter is able to outperform more expensive produc

THE DATA INPUT

A CMOS / TTL level data input is provided on Pin 2. This line is normally supplied with a serial bitstream input directly from a microprocessor, encoder, or UART. During standby, or the input of a logic low, the carrier is fully suppressed and the transmitter consumes less than 2µA of current. During a logic high, the transmitter generates a carrier to indicate to the receiver the presence of a logic '1'. The applied data should not exceed a rate of 5,000bps. The data input line should always be driven with a voltage common to the supply voltage present on Pin 7 (V_{CC}) and should never be allowed to exceed the supply voltage.

ADJUSTING THE OUTPUT POWER

Depending on the type of antenna being used and the duty cycle of the data, the output power of the LC Series transmitter module may be higher than FCC regulations allow. The output power of the module is intentionally set high to compensate for losses resulting from inefficient antennas that may be used to realize cost or space savings. Since attenuation is often required, it is generally wise to provide for its implementation and allow the FCC test lab to easily attenuate the transmitter to the maximum legal limit for your product.

Two methods of attenuation are available using the LC Series transmitter module. First, a resistor may be placed between Pin 4 (LADJ) and ground to achieve up to a 7dB reduction in output power. The resistor value is easily determined from Figure 7 on Page 3. Do not exceed the resistance values shown as transmitter instability may result. This method can also be used to reduce the transmission range and power consumption.

Another method commonly used to achieve attenuation, particularly at higher levels, is the use of a T-pad attenuator. A T-pad is a network of three resistors that allows for variable attenuation while maintaining the correct match to the antenna. It is usually prudent to allow space for the addition of a T-pad. An example of a T-pad attenuator layout is shown in the figure below. For further details on T-pad attenuators, please refer to Application Note AN-00150.

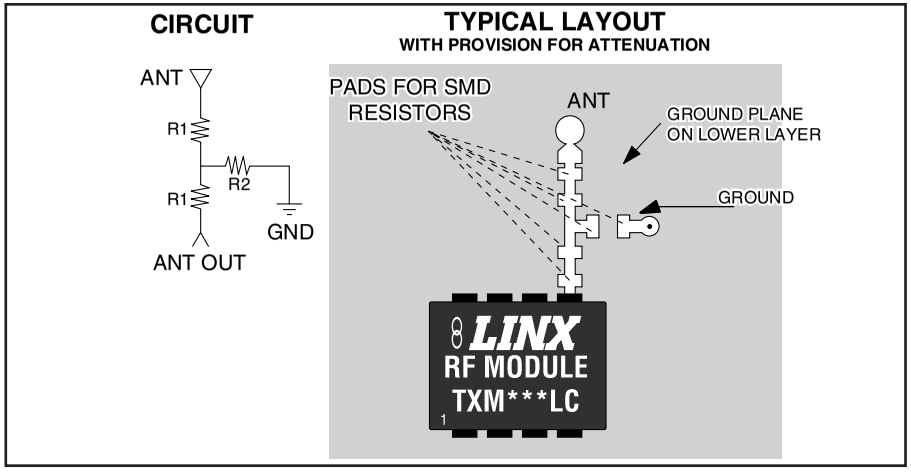


Figure 10: A T-Pad Attenuator Layout Example

POWER SUPPLY REQUIREMENTS

The module does not have an internal voltage regulator; therefore it requires clean, well-regulated power source. While it is preferable to power the unit fr a battery, the unit can also be operated from a power supply as long as noise less than 20mV. Power supply noise can significantly affect the transmitter modulation; therefore, providing a clean power supply for the module should be a high design priority.

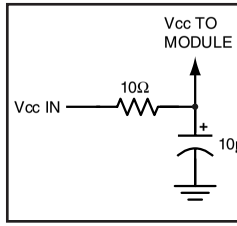


Figure 11: Supply Filter

A 10Ω resistor in series with the supply followed by a 10µF tantalum capacitor from V_{CC} to ground will help in cases where the quality of supply power is poor. These values may need to be adjusted depending on the noise present on the supply line.

TRANSMITTING DATA

Once a reliable RF link has been established, the challenge becomes how effectively transfer data across it. While a properly designed RF link provid reliable data transfer under most conditions, there are still distinct differenc from a wired link that must be addressed. Since the LC Series modules do n incorporate internal encoding or decoding, a user has tremendous flexibility how data is handled.

If you want to transfer simple control or status signals, such as button presses switch closures, and your product does not have a microprocessor on board, you wish to avoid protocol development, consider using an encoder and decod IC set. These chips are available from a range of manufacturers, including Li They take care of all encoding and decoding functions and generally provide number of data pins to which switches can be directly connected. In additio address bits are usually provided for security and to allow the addressing multiple units independently. These ICs are an excellent way to bring ba remote control / status products to market quickly and inexpensive Additionally, it is a simple task to interface with inexpensive microprocesso such as the Microchip PIC, or one of many IR, remote control, or modem ICs

It is always important to separate what types of transmissions are technica possible from those that are legally allowable in the country of intend operation. While the LR Series is ideally suited to the long range transfer control and command information, it can also be used with great success for t transfer of true variable data such as temperature, pressure, or sensor da However, the 260 - 470MHz band in which the module operates is regulated Part 15, Section 231 of the FCC regulations. Many types of transmissio especially those involving automatic transmissions or variable data, may need be periodic. You may wish to review Application Notes AN-00125 and AN-001 along with Part 15, Section 231 of the FCC regulations for further details acceptable transmission content in the Unites States.

Another area of consideration is that of data structure or protocol. The da should be formatted in a predictable way and should be able to deal with erro due to interference. This will ensure that the data is received and interpret correctly. If you are not familiar with the considerations for sending serial data a wireless environment, you will want to review Application Note AN-00160.

PROTOCOL GUIDELINES

While many RF solutions impose data formatting and balancing requirements, Linx RF modules do not encode or packetize the signal content in any manner. The received signal will be affected by such factors as noise, edge jitter, and interference, but it is not purposefully manipulated or altered by the modules. This gives the designer tremendous flexibility for protocol design and interface.

Despite this transparency and ease of use, it must be recognized that there are distinct differences between a wired and a wireless environment. Issues such as interference and contention must be understood and allowed for in the design process. To learn more about protocol considerations, we suggest you read Linx Application Note AN-00160.

Errors from interference or changing signal conditions can cause corruption of the data packet, so it is generally wise to structure the data being sent into small packets. This allows errors to be managed without affecting large amounts of data. A simple checksum or CRC could be used for basic error detection. Once an error is detected, the protocol designer may wish to simply discard the corrupt data or implement a more sophisticated scheme to correct it.

INTERFERENCE CONSIDERATIONS

The RF spectrum is crowded and the potential for conflict with other unwanted sources of RF is very real. While all RF products are at risk from interference, its effects can be minimized by better understanding its characteristics.

Interference may come from internal or external sources. The first step is to eliminate interference from noise sources on the board. This means paying careful attention to layout, grounding, filtering, and bypassing in order to eliminate all radiated and conducted interference paths. For many products, this is straightforward; however, products containing components such as switching power supplies, motors, crystals, and other potential sources of noise must be approached with care. Comparing your own design with a Linx evaluation board can help to determine if and at what level design-specific interference is present.

External interference can manifest itself in a variety of ways. Low-level interference will produce noise and hashing on the output and reduce the link's overall range.

High-level interference is caused by nearby products sharing the same frequency or from near-band high-power devices. It can even come from your own products if more than one transmitter is active in the same area. It is important to remember that only one transmitter at a time can occupy a frequency, regardless of the coding of the transmitted signal. This type of interference is less common than those mentioned previously, but in severe cases it can prevent all useful function of the affected device.

Although technically it is not interference, multipath is also a factor to be understood. Multipath is a term used to refer to the signal cancellation effects that occur when RF waves arrive at the receiver in different phase relationships. This effect is a particularly significant factor in interior environments where objects provide many different signal reflection paths. Multipath cancellation results in lowered signal levels at the receiver and, thus, shorter useful distances for the link.

TYPICAL APPLICATIONS

The LC Series transmitter is ideal for the transmission of remote contro command data. One of the easiest way to transmit on / off data or swit closures is to use an encoder and decoder. These ICs provide a number of da lines that can be connected to switches or buttons or even a microcontroll When a line is taken high on the encoder, a corresponding line will go high the decoder as long as the address matches. The figure below shows example using the Linx MS Series encoder.

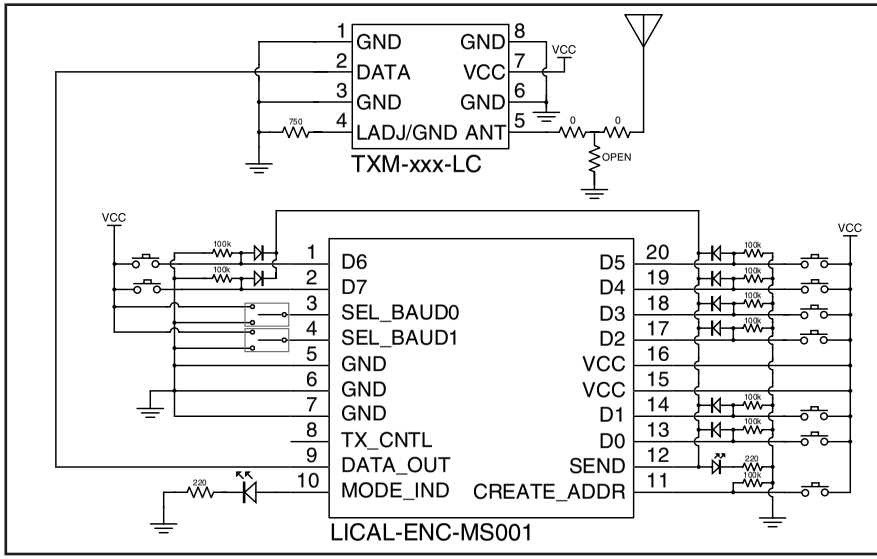


Figure 12: Typical Remote Control Example

This circuit uses the LC Series transmitter and the MS Series encoder to transm button presses. The MS Series has eight data lines, which are connected buttons that will pull the line high when pressed. When not used, the lines a pulled low by 100kΩ resistors. The encoder will begin a transmission only wh the SEND line is taken high. Diodes are used to pull this line high when any da line is pulled high while isolating the data lines from each other.

The MS Series Encoder Data Guide explains this circuit and the many featur of the encoder in detail, so please refer to that document for more information

A 750Ω resistor is used on the LADJ line of the transmitter to reduce the outp power of the transmitter. This is appropriate for some antennas, but may need be adjusted depending on the design. Typically, a resistor pad will be placed the board and a potentiometer used by the FCC test lab to adjust the outp power to the maximum legal limit. The potentiometer value would then measured and the closest standard value resistor placed for final testing.

If the level adjust resistor does not provide enough attenuation, a T-p attenuator can be placed between the transmitter and antenna. This is a netwo of three resistors that will provide a set amount of attenuation while maintaini a 50Ω match between the antenna and the transmitter. Application No AN-00150 gives the formulas for calculating the resistor values. If not neede the series resistors can be zero ohms or shorted and the parallel one not place

BOARD LAYOUT GUIDELINES

If you are at all familiar with RF devices, you may be concerned about specialized board layout requirements. Fortunately, because of the care taken by Linx in designing the modules, integrating them is very straightforward. Despite this ease of application, it is still necessary to maintain respect for the RF stage and exercise appropriate care in layout and application in order to maximize performance and ensure reliable operation. The antenna can also be influenced by layout choices. Please review this data guide in its entirety prior to beginning your design. By adhering to good layout principles and observing some basic design rules, you will be on the path to RF success.

The adjacent figure shows the suggested PCB footprint for the module. The actual pad dimensions are shown in the Pad Layout section of this manual. A ground plane (as large as possible) should be placed on a lower layer of your PC board opposite the module. This ground plane can also be critical to the performance of your antenna, which will be discussed later. There should not be any ground or traces under the module on the same layer as the module, just bare PCB.

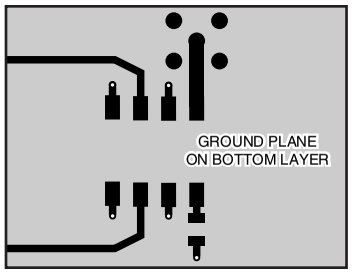


Figure 13: Suggested PCB Layout

During prototyping, the module should be soldered to a properly laid-out circuit board. The use of prototyping or "perf" boards will result in horrible performance and is strongly discouraged.

No conductive items should be placed within 0.15in of the module's top or sides.

Do not route PCB traces directly under the module. The underside of the module has numerous signal-bearing traces and vias that could short or couple to traces on the product's circuit board.

The module's ground lines should each have their own via to the ground plane and be as short as possible.

AM / OOK receivers are particularly subject to noise. The module should, as much as reasonably possible, be isolated from other components on your PCB, especially high-frequency circuitry such as crystal oscillators, switching power supplies, and high-speed bus lines. Make sure internal wiring is routed away from the module and antenna, and is secured to prevent displacement.

The power supply filter should be placed close to the module's V_{CC} line.

In some instances, a designer may wish to encapsulate or "pot" the product. Many Linx customers have done this successfully; however, there are a wide variety of potting compounds with varying dielectric properties. Since such compounds can considerably impact RF performance, it is the responsibility of the designer to carefully evaluate and qualify the impact and suitability of such materials.

The trace from the module to the antenna should be kept as short as possible. A simple trace is suitable for runs up to 1/8-inch for antennas with wide bandwidth characteristics. For longer runs or to avoid detuning narrow bandwidth antennas, such as a helical, use a 50-ohm coax or 50-ohm microstrip transmission line as described in the following section.

MICROSTRIP DETAILS

A transmission line is a medium whereby RF energy is transferred from o place to another with minimal loss. This is a critical factor, especially in hig frequency products like Linx RF modules, because the trace leading to t module's antenna can effectively contribute to the length of the antenn changing its resonant bandwidth. In order to minimize loss and detuning, son form of transmission line between the antenna and the module should be use unless the antenna can be placed very close (<1/8in.) to the module. O common form of transmission line is a coax cable, another is the microstrip. Th term refers to a PCB trace running over a ground plane that is designed to ser as a transmission line between the module and the antenna. The width is bas on the desired characteristic impedance of the line, the thickness of the PC and the dielectric constant of the board material. For standard 0.062in thick F 4 board material, the trace width would be 111 mils. The correct trace width c be calculated for other widths and materials using the information below. Han software for calculating microstrip lines is also available on the Linx websi www.linxtechnologies.com.

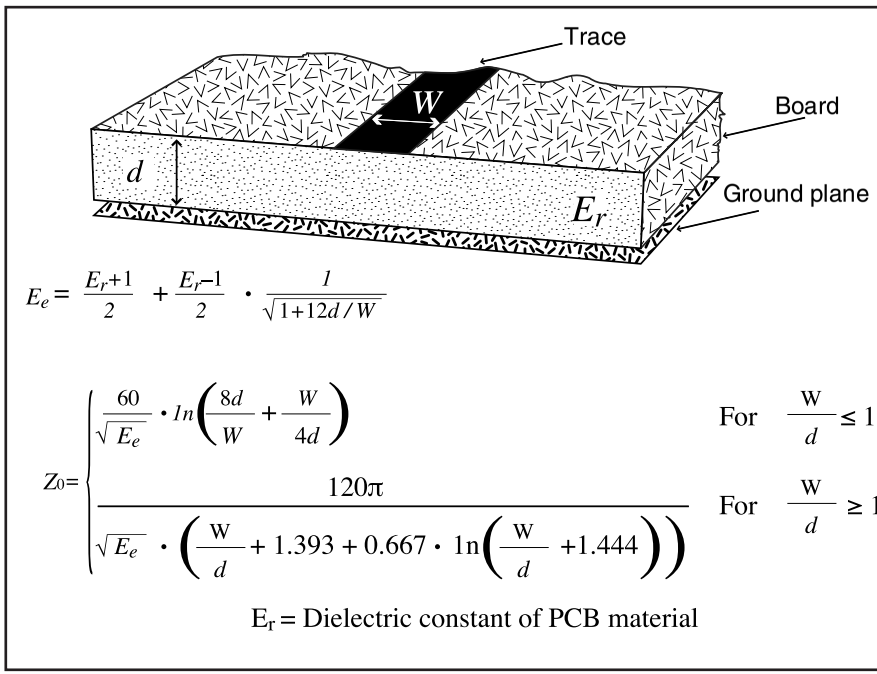


Figure 12: Microstrip Formulas

Dielectric Constant	Width/Height (W/d)	Effective Dielectric Constant	Characteristic Impedance
4.80	1.8	3.59	50.0
4.00	2.0	3.07	51.0
2.55	3.0	2.12	48.0

PAD LAYOUT

The following pad layout diagram is designed to facilitate both hand and automated assembly.

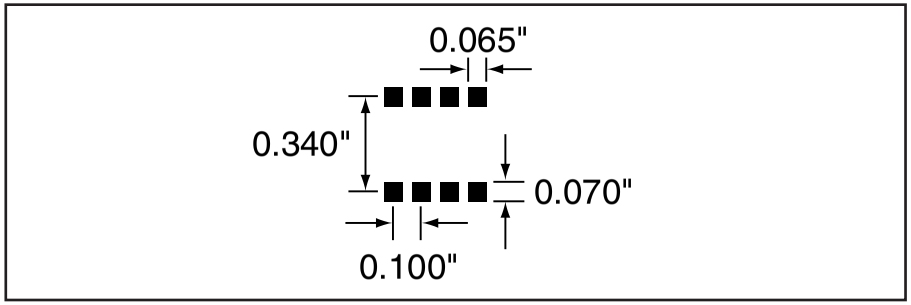


Figure 15: Recommended PCB Layout

PRODUCTION GUIDELINES

The modules are housed in a hybrid SMD package that supports hand or automated assembly techniques. Since the modules contain discrete components internally, the assembly procedures are critical to ensuring the reliable function of the modules. The following procedures should be reviewed with and practiced by all assembly personnel.

HAND ASSEMBLY

Pads located on the bottom of the module are the primary mounting surface. Since these pads are inaccessible during mounting, castellations that run up the side of the module have been provided to facilitate solder wicking to the module's underside. This allows for very quick hand soldering for prototyping and small volume production.

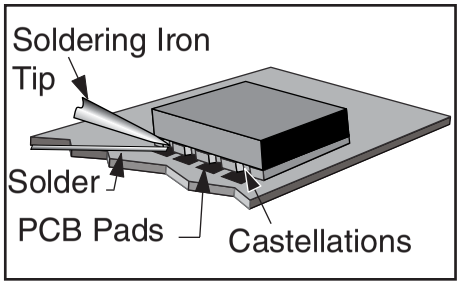


Figure 16: Soldering Technique

If the recommended pad guidelines have been followed, the pads will protrude slightly past the edge of the module. Use a fine soldering tip to heat the board pad and the castellation, then introduce solder to the pad at the module's edge. The solder will wick underneath the module, providing reliable attachment. Tack one module corner first and then work around the device, taking care not to exceed the times listed below.

Absolute Maximum Solder Times

Hand-Solder Temp. TX +225°C for 10 Seconds
Hand-Solder Temp. RX +225°C for 10 Seconds
Recommended Solder Melting Point +180°C
Reflow Oven: +220°C Max. (See adjoining diagram)

AUTOMATED ASSEMBLY

For high-volume assembly, most users will want to auto-place the modules. T modules have been designed to maintain compatibility with reflow processi techniques; however, due to the their hybrid nature, certain aspects of t assembly process are far more critical than for other component types.

Following are brief discussions of the three primary areas where caution must observed.

Reflow Temperature Profile

The single most critical stage in the automated assembly process is the refl stage. The reflow profile below should not be exceeded, since excessi temperatures or transport times during reflow will irreparably damage t modules. Assembly personnel will need to pay careful attention to the ove profile to ensure that it meets the requirements necessary to successfully refl all components while still remaining within the limits mandated by the module The figure below shows the recommended reflow oven profile for the module

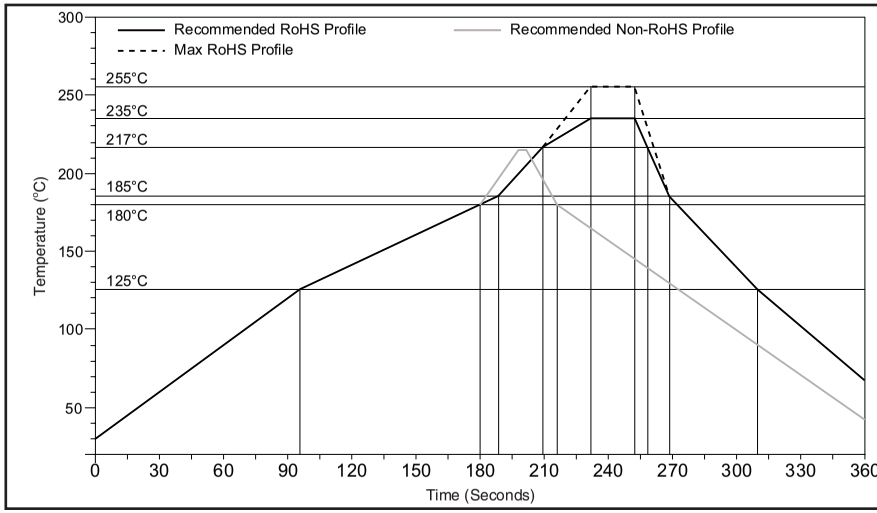


Figure 17: Maximum Reflow Profile

Shock During Reflow Transport

Since some internal module components may reflow along with the componer placed on the board being assembled, it is imperative that the modules not subjected to shock or vibration during the time solder is liquid. Should a sho be applied, some internal components could be lifted from their pads, causi the module to not function properly.

Washability

The modules are wash resistant, but are not hermetically sealed. Li recommends wash-free manufacturing; however, the modules can be subject to a wash cycle provided that a drying time is allowed prior to applying electri power to the modules. The drying time should be sufficient to allow any moistu that may have migrated into the module to evaporate, thus eliminating t potential for shorting damage during power-up or testing. If the wash contai contaminants, the performance may be adversely affected, even after drying.

ANTENNA CONSIDERATIONS

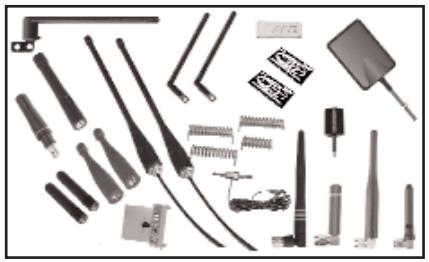


Figure 18: Linx Antennas

The choice of antennas is a critical and often overlooked design consideration. The range, performance, and legality of an RF link are critically dependent upon the antenna. While adequate antenna performance can often be obtained by trial and error methods, antenna design and matching is a complex task. A professionally designed antenna, such as those from Linx, will help ensure maximum performance and FCC compliance.

Linx transmitter modules typically have an output power that is slightly higher than the legal limits. This allows the designer to use an inefficient antenna, such as a loop trace or helical, to meet size, cost, or cosmetic requirements and still achieve full legal output power for maximum range. If an efficient antenna is used, then some attenuation of the output power will likely be needed. This can easily be accomplished by using the LADJ line or a T-pad attenuator. For more details on T-pad attenuator design, please see Application Note AN-00150.

A receiver antenna should be optimized for the frequency or band in which the receiver operates and to minimize the reception of off-frequency signals. The efficiency of the receiver's antenna is critical to maximizing range performance. Unlike the transmitter antenna, where legal operation may mandate attenuation or a reduction in antenna efficiency, the receiver's antenna should be optimized as much as is practical.

It is usually best to utilize a basic quarter-wave whip until your prototype product is operating satisfactorily. Other antennas can then be evaluated based on the cost, size, and cosmetic requirements of the product. You may wish to review Application Note AN-00500 "Antennas: Design, Application, Performance"

ANTENNA SHARING

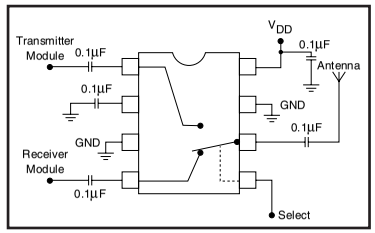


Figure 19: Typical Antenna Switch

In cases where a transmitter and receiver module are combined to form a transceiver, it is often advantageous to share a single antenna. To accomplish this, an antenna switch must be used to provide isolation between the modules so that the full transmitter output power is not put on the sensitive front end of the receiver. There are a wide variety of antenna switches that are cost-effective and easy to use. Among the most popular are switches from Macom and NEC. Look for an antenna switch that has high isolation and low loss at the desired frequency of operation. Generally, the Tx or Rx status of a switch will be controlled by a product's microprocessor, but the user may also make the selection manually. In some cases, where the characteristics of the Tx and Rx antennas need to be different or antenna switch losses are unacceptable, it may be more appropriate to utilize two discrete antennas.

GENERAL ANTENNA RULES

The following general rules should help in maximizing antenna performance.

1. Proximity to objects such as a user's hand, body, or metal objects will cause antenna to detune. For this reason, the antenna shaft and tip should positioned as far away from such objects as possible.

2. Optimum performance will be obtained from a 1/4- or 1/2-wave straight whip mounted at a right angle to the ground plane. In many cases, this isn't desirable for practical or ergonomic reasons, thus, an alternative antenna style such as a helical, loop, or patch may be utilized and the corresponding sacrifice in performance accepted.

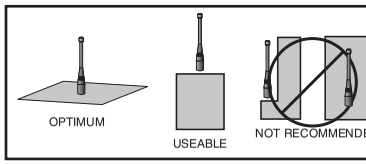


Figure 20: Ground Plane Orientation

3. If an internal antenna is to be used, keep it away from other metal componen particularly large items like transformers, batteries, PCB tracks, and grou planes. In many cases, the space around the antenna is as important as t antenna itself. Objects in close proximity to the antenna can cause dire detuning, while those farther away will alter the antenna's symmetry.

4. In many antenna designs, particularly 1/4-wave whips, the ground plane acts as a counterpoise, forming, in essence, a 1/2-wave dipole. For this reason, adequate ground plane area is essential. The ground plane can be a metal case or ground-fill areas on a circuit board. Ideally, it should have a surface area ≥ the overall length of the 1/4-wave radiating element. This is often not practical due to size and configuration constraints. In these instances, a designer must make the best use of the area available to create as much ground plane as possible in proximity to the base of the antenna. In cases where the antenna remotely located or the antenna is not in close proximity to a circuit boa ground plane, or grounded metal case, a metal plate may be used to maximi the antenna's performance.

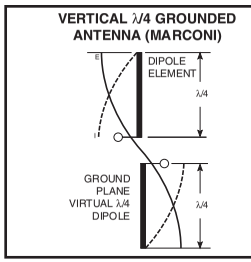


Figure 21: Dipole Antenna

5. Remove the antenna as far as possible from potential interference sources. A frequency of sufficient amplitude to enter the receiver's front end will redu system range and can even prevent reception entirely. Switching pow supplies, oscillators, or even relays can also be significant sources of potent interference. The single best weapon against such problems is attention placement and layout. Filter the module's power supply with a high-frequen bypass capacitor. Place adequate ground plane under potential sources of noi to shunt noise to ground and prevent it from coupling to the RF stage. Shie noisy board areas whenever practical.

6. In some applications, it is advantageous to place the module and antenna away from the main equipment. This can avoid interference problems and allows the antenna to be oriented for optimum performance. Always use 50Ω coax, like RG-174, for the remote feed.

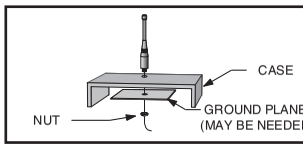


Figure 22: Remote Ground Pla

COMMON ANTENNA STYLES

There are literally hundreds of antenna styles and variations that can be employed with Linx RF modules. Following is a brief discussion of the styles most commonly utilized. Additional antenna information can be found in Linx Application Notes AN-00100, AN-00140, and AN-00500. Linx antennas and connectors offer outstanding performance at a low price.

Whip Style

$$L = \frac{234}{F_{MHz}}$$

Where:
L = length in feet of quarter-wave length
F = operating frequency in megahertz

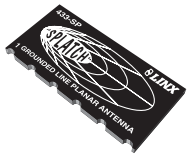
A whip-style antenna provides outstanding overall performance and stability. A low-cost whip is can be easily fabricated from a wire or rod, but most designers opt for the consistent performance and cosmetic appeal of a professionally-made model. To meet this need, Linx offers a wide variety of straight and reduced-height whip-style antennas in permanent and connectorized mounting styles.

The wavelength of the operational frequency determines an antenna's overall length. Since a full wavelength is often quite long, a partial 1/2- or 1/4-wave antenna is normally employed. Its size and natural radiation resistance make it well matched to Linx modules. The proper length for a straight 1/4-wave can be easily determined using the adjacent formula. It is also possible to reduce the overall height of the antenna by using a helical winding. This reduces the antenna's bandwidth, but is a great way to minimize the antenna's physical size for compact applications. This also means that the physical appearance is not always an indicator of the antenna's frequency.

Specialty Styles

Linx offers a wide variety of specialized antenna styles. Many of these styles utilize helical elements to reduce the overall antenna size while maintaining reasonable performance. A helical antenna's bandwidth is often quite narrow and the antenna can detune in proximity to other objects, so care must be exercised in layout and placement.

Loop Style



A loop- or trace-style antenna is normally printed directly on a product's PCB. This makes it the most cost-effective of antenna styles. The element can be made self-resonant or externally resonated with discrete components, but its actual layout is usually product specific. Despite the cost advantages, loop-style antennas are generally inefficient and useful only for short-range applications. They are also very sensitive to changes in layout and PCB dielectric, which can cause consistency issues during production. In addition, printed styles are difficult to engineer, requiring the use of expensive equipment, including a network analyzer. An improperly designed loop will have a high SWR at the desired frequency, which can cause instability in the RF stage.

Linx offers low-cost planar and chip antennas that mount directly to a product's PCB. These tiny antennas do not require testing and provide excellent performance in light of their small size. They offer a preferable alternative to the often-problematic "printed" antenna.

ONLINE RESOURCES

LINX® TECHNOLOGIES

www.linxtechnologies.com

- **Latest News**
- **Data Guides**
- **Application Notes**
- **Knowledgebase**
- **Software Updates**

If you have questions regarding any Linx product and have Internet acces make www.linxtechnologies.com your first stop. Our website is organized in intuitive format to immediately give you the answers you need. Day or night, t Linx website gives you instant access to the latest information regarding t products and services of Linx. It's all here: manual and software update application notes, a comprehensive knowledgebase, FCC information, and mu more. Be sure to visit often!

ANTENNA FACTOR

www.antennafactor.com

The Antenna Factor division of Linx offers a diverse array of antenna styles, many of which are optimized for use with our RF modules. From innovative embeddable antennas to low-cost whips, domes to Yagis, and even GPS, Antenna Factor likely has an antenna for you, or can design one to meet your requirements.

CONNECTOR CITY
THE VALUE OF CONNECTIONS

www.connectorcity.com

Through its Connector City division, Linx offers a wide selection of high-quality RF connectors, including FCC-compliant types such as RP-SMAs that are an ideal match for our modules and antennas. Connector City focuses on high-volume OEM requirements, which allows standard and custom RF connectors to be offered at a remarkably low cost.

LEGAL CONSIDERATIONS

NOTE: Linx RF modules are designed as component devices that require external components to function. The modules are intended to allow for full Part 15 compliance; however, they are not approved by the FCC or any other agency worldwide. The purchaser understands that approvals may be required prior to the sale or operation of the device, and agrees to utilize the component in keeping with all laws governing its use in the country of operation.

When working with RF, a clear distinction must be made between what is technically possible and what is legally acceptable in the country where operation is intended. Many manufacturers have avoided incorporating RF into their products as a result of uncertainty and even fear of the approval and certification process. Here at Linx, our desire is not only to expedite the design process, but also to assist you in achieving a clear idea of what is involved in obtaining the necessary approvals to legally market your completed product.

In the United States, the approval process is actually quite straightforward. The regulations governing RF devices and the enforcement of them are the responsibility of the Federal Communications Commission (FCC). The regulations are contained in Title 47 of the Code of Federal Regulations (CFR). Title 47 is made up of numerous volumes; however, all regulations applicable to this module are contained in Volume 0-19. It is strongly recommended that a copy be obtained from the Government Printing Office in Washington or from your local government bookstore. Excerpts of applicable sections are included with Linx evaluation kits or may be obtained from the Linx Technologies website, www.linxtechnologies.com. In brief, these rules require that any device that intentionally radiates RF energy be approved, that is, tested for compliance and issued a unique identification number. This is a relatively painless process. Linx offers full EMC pre-compliance testing in our HP / Emco-equipped test center. Final compliance testing is then performed by one of the many independent testing laboratories across the country. Many labs can also provide other certifications that the product may require at the same time, such as UL, CLASS A / B, etc. Once your completed product has passed, you will be issued an ID number that is to be clearly placed on each product manufactured.

Questions regarding interpretations of the Part 2 and Part 15 rules or measurement procedures used to test intentional radiators, such as Linx RF modules, for compliance with the technical standards of Part 15, should be addressed to:

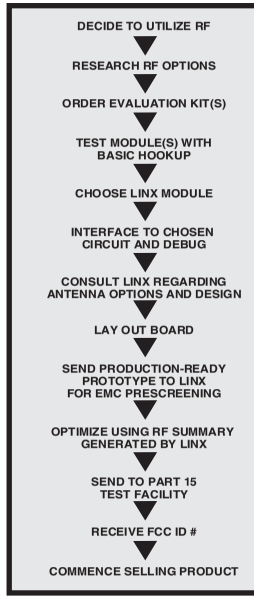
Federal Communications Commission
Equipment Authorization Division
Customer Service Branch, MS 1300F2
7435 Oakland Mills Road
Columbia, MD 21046
Phone: (301) 725-1585 Fax: (301) 344-2050 E-Mail: labinfo@fcc.gov

International approvals are slightly more complex, although Linx modules are designed to allow all international standards to be met. If you are considering the export of your product abroad, you should contact Linx Technologies to determine the specific suitability of the module to your application.

All Linx modules are designed with the approval process in mind and thus much of the frustration that is typically experienced with a discrete design is eliminated. Approval is still dependent on many factors, such as the choice of antennas, correct use of the frequency selected, and physical packaging. While some extra cost and design effort are required to address these issues, the additional usefulness and profitability added to a product by RF makes the effort more than worthwhile.

ACHIEVING A SUCCESSFUL RF IMPLEMENTATION

Adding an RF stage brings an exciting new dimension to any product. It also means that additional effort and commitment will be needed to bring the product successfully to market. By utilizing premade RF modules, such as the LR Series, the design and approval process is greatly simplified. It is still important, however, to have an objective view of the steps necessary to ensure a successful RF integration. Since the capabilities of each customer vary widely, it is difficult to recommend one particular design path, but most projects follow steps similar to those shown at the right.



Typical Steps For Implementing RF

In reviewing this sample design path, you may notice that Linx offers a variety of services (such as antenna design and FCC prequalification) that are unusual for a high-volume component manufacturer. These services, along with an exceptional level of technical support, are offered because we recognize that RF is a complex science requiring the highest caliber of products and support. “Wireless Made Simple” is more than just a motto, it’s our commitment. By choosing Linx as your RF partner and taking advantage of the resources we offer, you will not only survive implementing RF, you may even find the process enjoyab

HELPFUL APPLICATION NOTES FROM LINX

It is not the intention of this manual to address in depth many of the issues th should be considered to ensure that the modules function correctly and deliv the maximum possible performance. As you proceed with your design, you m wish to obtain one or more of the following application notes, which address depth key areas of RF design and application of Linx products. The applications notes are available online at www.linxtechnologies.com or contacting the Linx literature department.

NOTE	APPLICATION NOTE TITLE
AN-00100	RF 101: Information for the RF Challenged
AN-00125	Considerations For Operation Within The 260-470MHz Band
AN-00130	Modulation Techniques For Low-Cost RF Data Links
AN-00140	The FCC Road: Part 15 From Concept To Approval
AN-00150	Use and Design of T-Attenuation Pads
AN-00160	Considerations For Sending Data Over a Wireless Link
AN-00232	General Considerations For Sending Data With The LC Series
AN-00500	Antennas: Design, Application, Performance

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